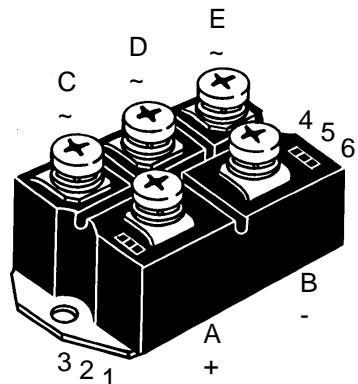
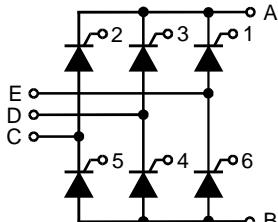


# Three Phase Full Controlled Rectifier Bridge, B6C

**I<sub>dAVM</sub> = 110/167 A**  
**V<sub>RRM</sub> = 1200-1600 V**

V <sub>RSM</sub>	V <sub>RRM</sub>	Type
V <sub>DSM</sub>	V <sub>DRM</sub>	
V	V	
1300	1200	VTO 110-12io7
1500	1400	VTO 110-14io7
1700	1600	VTO 175-16io7



Symbol	Test Conditions	Maximum Ratings	
		VTO 110	VTO 175
I <sub>dAV</sub> , I <sub>FRMS</sub> , I <sub>TRMS</sub>	T <sub>C</sub> = 85°C; module per leg	110 58	167 89
I <sub>FSM</sub> , I <sub>TSM</sub>	T <sub>VJ</sub> = 45°C; V <sub>R</sub> = 0 t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	1150 1230	1500 1600
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0 t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	1000 1070	1350 1450
I <sub>t</sub>	T <sub>VJ</sub> = 45°C V <sub>R</sub> = 0 t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	6600 6280	11200 10750
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0 t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	5000 4750	9100 8830
(di/dt) <sub>cr</sub>	T <sub>VJ</sub> = T <sub>VJM</sub> repetitive, I <sub>T</sub> = 50 A f = 400 Hz, t <sub>p</sub> = 200 µs V <sub>D</sub> = 2/3 V <sub>DRM</sub> I <sub>G</sub> = 0.3 A, non repetitive di <sub>G</sub> /dt = 0.3 A/µs, I <sub>T</sub> = 1/3 • I <sub>dAV</sub>	150	A/µs
		500	A/µs
(dv/dt) <sub>cr</sub>	T <sub>VJ</sub> = T <sub>VJM</sub> ; V <sub>DR</sub> = 2/3 V <sub>DRM</sub> R <sub>GK</sub> = ∞; method 1 (linear voltage rise)	1000	V/µs
V <sub>RGM</sub>		10	V
P <sub>GM</sub>	T <sub>VJ</sub> = T <sub>VJM</sub> I <sub>T</sub> = I <sub>TAVM</sub> t <sub>p</sub> = 30 µs t <sub>p</sub> = 500 µs t <sub>p</sub> = 10 ms	≤ 10 ≤ 5 ≤ 1 0.5	W W W W
P <sub>GAVM</sub>		-40...+125 125 -40...+125	°C °C °C
T <sub>VJ</sub> T <sub>VJM</sub> T <sub>stg</sub>			
V <sub>ISOL</sub>	50/60 Hz, RMS t = 1 min I <sub>ISOL</sub> ≤ 1 mA t = 1 s	2500 3000	V~ V~
M <sub>d</sub>	Mounting torque (M6)	5-15	Nm
	Terminal connection torque (M6)	5-15	lb.in.
Weight	typ.	300	g

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.  
 IXYS reserves the right to change limits, test conditions and dimensions.

Symbol	Test Conditions	Characteristic Values		
		VTO 110	VTO 175	
$I_R, I_D$	$V_R = V_{RRM}$ ; $V_D = V_{DRM}$ $T_{VJ} = T_{VJM}$ $T_{VJ} = 25^\circ C$	$\leq$ $\leq$	5 0.3	mA mA
$V_F, V_T$	$I_F, I_T = 200 A$ , $T_{VJ} = 25^\circ C$	$\leq$	1.75	1.57 V
$V_{TO}$ $r_T$	For power-loss calculations only $(T_{VJ} = 125^\circ C)$		0.85 6	0.85 V 3.5 mΩ
$V_{GT}$	$V_D = 6 V$ ; $T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$	$\leq$ $\leq$	1.5 1.6	V V
$I_{GT}$	$V_D = 6 V$ ; $T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$	$\leq$ $\leq$	100 200	mA mA
$V_{GD}$ $I_{GD}$	$T_{VJ} = T_{VJM}$ ; $V_D = 2/3 V_{DRM}$ $T_{VJ} = T_{VJM}$ ; $V_D = 2/3 V_{DRM}$	$\leq$ $\leq$	0.2 5	V mA
$I_L$	$I_G = 0.3 A$ ; $t_g = 30 \mu s$ $di_g/dt = 0.3 A/\mu s$	$\leq$	450	mA
$I_H$	$T_{VJ} = 25^\circ C$ ; $V_D = 6 V$ ; $R_{GK} = \infty$	$\leq$	200	mA
$t_{gd}$	$T_{VJ} = 25^\circ C$ ; $V_D = 1/2 V_{DRM}$ $I_G = 0.3 A$ ; $di_g/dt = 0.3 A/\mu s$	$\leq$	2	μs
$R_{thJC}$	per thyristor (diode); DC current per module	0.65 0.108	0.46 0.077	K/W K/W
$R_{thJH}$	per thyristor (diode); DC current per module	0.8 0.133	0.55 0.092	K/W K/W
$d_s$ $d_A$ $a$	Creeping distance on surface Creepage distance in air Max. allowable acceleration		10 9.4 50	mm mm m/s <sup>2</sup>

Dimensions in mm (1 mm = 0.0394")

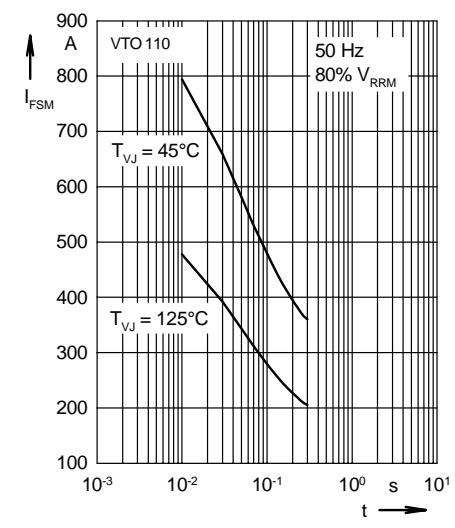
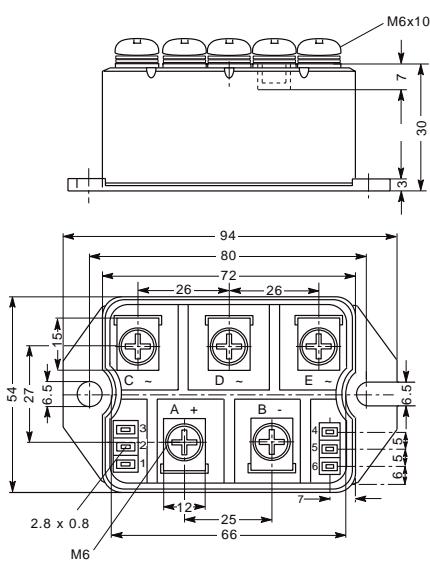


Fig. 3 Surge overload current  
 $I_{FSM}$ : Crest value,  $t$ : duration

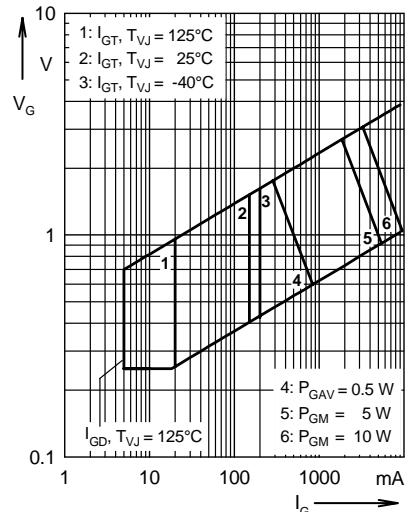


Fig. 1 Gate trigger characteristics

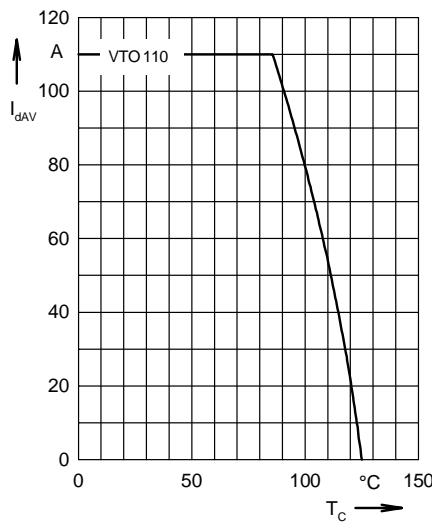


Fig. 2 DC output current at case temperature

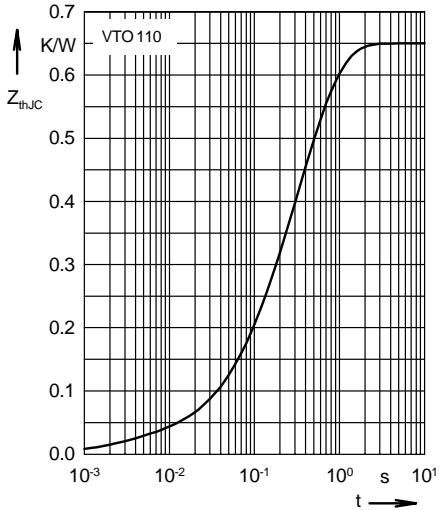


Fig. 4 Transient thermal impedance junction to case (per leg)